



欧智通科技

Fn-Link

6223A-SRD

WiFi Single-band 1X1 +
Bluetooth v2.1+EDR/Bluetooth
3.0/3.0+HS/4.2

User's Manual

Revision History

Date	Revision Content	Revised By	Version
2016-9-26	First Released	William Tan	1.0
2016-12-19	Modified pin definition and BT version	Colin Ming	1.1
2017-02-10	Modified reference design	Colin Ming	1.2

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1. Introduction

6223A-SRD is a small size and low profile of WiFi + BT Combo module with LGA (Land-Grid Array) footprint, board size is 12mm*12mm with module thickness of 2mm. It can be easily manufactured on SMT process and highly suitable for tablet PC, ultra book, mobile device and consumer products. It provides SDIO interface for WiFi to connect with host processor and high speed UART interface for BT. It also has a PCM interface for audio data transmission with direct link to external audio codec via BT controller. The WiFi throughput can go up to 150Mbps in theory by using 1x1 802.11n b/g/n SISO technology and Bluetooth can support BT2.1+EDR/BT3.0 and BT4.2.

6223A-SRD uses highly integrated WiFi/BT single chip based on advanced COMS process. 6223A-SRD integrates whole WiFi/BT function blocks into a chip, such as SDIO/UART, MAC, BB, AFE, RFE, PA, EEPROM and LDO/SWR, except fewer passive components remained on PCB.

This compact module is a total solution for a combination of Wi-Fi + BT technologies. The module is specifically developed for Smart phones and Portable devices.

2. Features

- Operate at ISM frequency bands (2.4GHz)
- SDIO for WiFi and UART for Bluetooth
- IEEE standards support: IEEE 802.11b, IEEE 802.11g, IEEE 802.11n, IEEE 802.11d, IEEE 802.11e, IEEE 802.11h, IEEE 802.11i
- Fully Qualified for Bluetooth 2.1+EDR specification including both 2Mbps and 3Mbps modulation mode
- Fully qualified for Bluetooth 3.0
- Fully qualified for Bluetooth 4.2 Dual mode
- Full-speed Bluetooth operation with Piconet and Scatternet support
- Enterprise level security which can apply WPA/WPA2 certification for WiFi.
- WiFi 1 transmitter and 1 receiver allow data rates supporting up to 150 Mbps downstream and 150 Mbps upstream PHY rates

3. General Specification

3.1 General Specification

Model Name	6223A-SRD
Product Description	Support WiFi/Bluetooth functionalities
Dimension	L x W x H: 12 x 12 x1.5 (typical) mm
WiFi Interface	Support SDIO V3.0
BT Interface	UART / PCM
Operating temperature	-20°C to 70°C
Storage temperature	-40°C to 85°C

3.2 Recommended Operating Rating

	Min.	Typ.	Max.	Unit
Operating Temperature	-20	25	70	deg.C
VCC33	3.15	3.3	3.45	V
VDDIO	1.7	1.8 or 3.3	3.45	V

4. WiFi/BT RF Specification

4.1 2.4GHz RF Specification

Feature	Description
Operating Frequency	2.400~2.4835GHz
Standards	WiFi: IEEE 802.11b, IEEE 802.11g, IEEE 802.11n, IEEE 802.11d, IEEE 802.11e, IEEE 802.11h, IEEE 802.11i BT: V2.1+EDR/BT v3.0/BT v3.0+HS/BT v4.2
Modulation	WiFi: 802.11b: CCK(11, 5.5Mbps), QPSK(2Mbps), BPSK(1Mbps), 802.11 g/n: OFDM BT: 8DPSK, $\pi/4$ DQPSK, GFSK
PHY Data rates	WiFi: 802.11b: 11,5.5,2,1 Mbps 802.11g: 54,48,36,24,18,12,9,6 Mbps 802.11n: up to 150Mbps BT: 1 Mbps for Basic Rate 2,3 Mbps for Enhanced Data Rate
EVM	802.11b /1Mbps : EVM \leq -10dB 802.11b /11Mbps : EVM \leq -10dB 802.11g /6Mbps : EVM \leq -5dB 802.11g /54Mbps : EVM \leq -25dB 802.11n /6.5Mbps : EVM \leq -5dB 802.11n /65Mbps : EVM \leq -28dB 802.11n /13.5Mbps : EVM \leq -5dB 802.11n /135Mbps : EVM \leq -28dB

Receiver Sensitivity (WiFi)	802.11b@8% PER	
	1Mbps \cong -91dBm	
	2Mbps \cong -89dBm	
	5.5Mbps \cong -87dBm	
	11Mbps \cong -85dBm Max input level \geq -8	
	802.11g@10% PER	
	6Mbps \cong -87dBm	
	9Mbps \cong -86dBm	
	12Mbps \cong -84dBm	
	18Mbps \cong -82dBm	
	24Mbps \cong -79dBm	
	36Mbps \cong -75dBm	
	48Mbps \cong -71dBm	
	54Mbps \cong -70dBm Max input level \geq -20	
	802.11n@10% PER	
	HT20_MCS 0 \cong -87dBm	HT40_MCS 0 \cong -84
	HT20_MCS 1 \cong -84dBm	HT40_MCS 1 \cong -81
	HT20_MCS 2 \cong -82dBm	HT40_MCS 2 \cong -79
	HT20_MCS 3 \cong -79dBm	HT40_MCS 3 \cong -76
	HT20_MCS 4 \cong -75dBm	HT40_MCS 4 \cong -72
	HT20_MCS 5 \cong -71dBm	HT40_MCS 5 \cong -68
	HT20_MCS 6 \cong -70dBm	HT40_MCS 6 \cong -67
	HT20_MCS 7 \cong -69dBm	HT40_MCS 7 \cong -66
	Max input level \geq -20	
Receiver Sensitivity (BT)	-89dBm @ 1Mbps	
	-86dBm @ 2Mbps	
	-83dBm @ 3Mbps	
Operating Channel	WiFi 2.4GHz: 11: (Ch. 1-11) – United States	
	BT 2.4GHz: Ch. 0 ~78	
Media Access Control	WiFi: CSMA/CA with ACK	
	BT: AFH, Time Division	
Antenna	External Antenna	
Network Architecture	WiFi: Ad-hoc mode (Peer-to-Peer) Infrastructure mode	

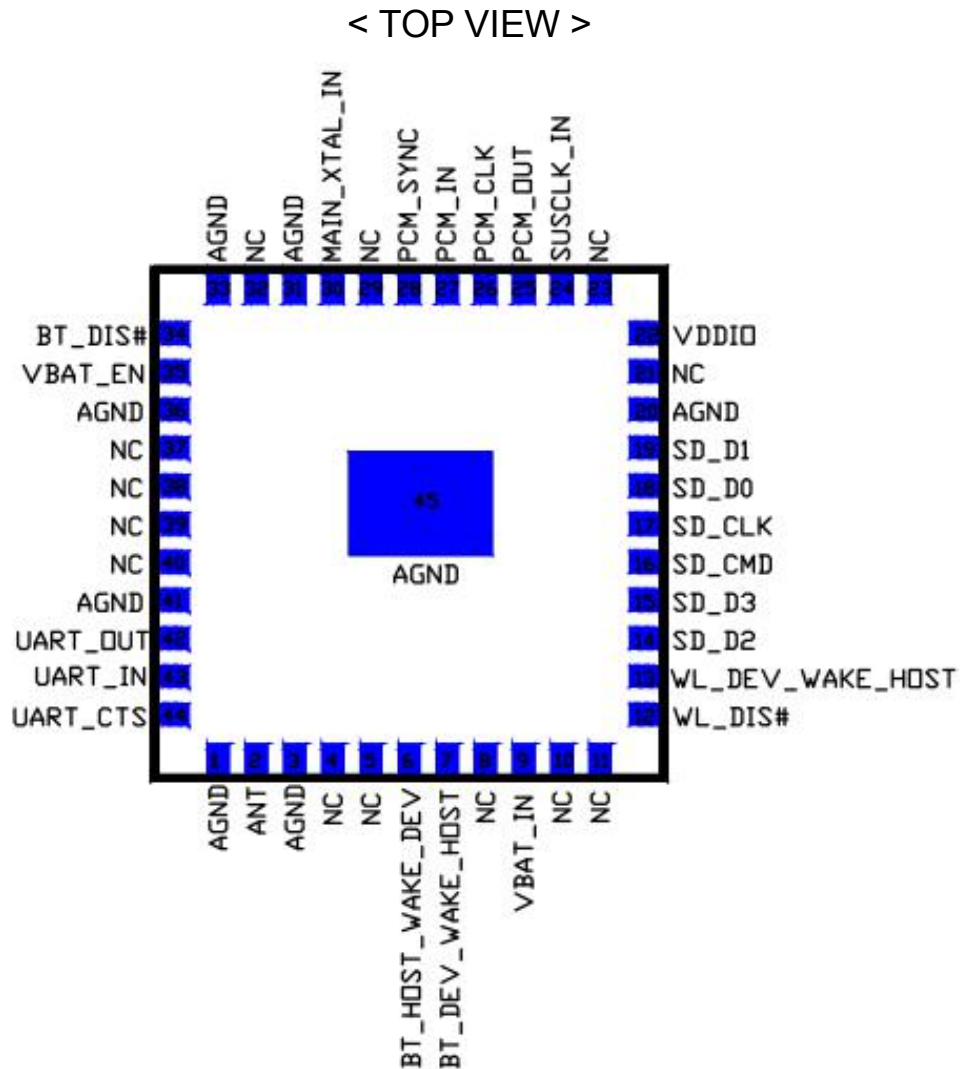
	Software AP WiFi Direct BT: Pico Net, Scatter Net
Security	WiFi: WPA, WPA-PSK, WPA2, WPA2-PSK, WEP 64bit & 128bit, IEEE 802.11x, IEEE 802.11i BT: Simple Paring
OS Supported	Android /Linux/ Win CE /iOS /XP/WIN7
Host Interface	WiFi: SDIO BT: UART
Operating Voltage	3.3±10% Vdc I/O supply voltage
Dimension	Typical L12.0*W12.0*H1.6mm

5. Power Consumption

Power Consumption (Typical by using SWR)	<p>WiFi only:</p> <p>TX Mode: (Throughput mode) 170mA (MCS7/BW40/13dBm) RX Mode: (Throughput mode) 130mA (MCS7/BW40/-60dBm) Associated Idle power saving with DTIM=3 2.1mA Unassociated Idle: 0.1mA RF disable Mode: 0.1mA</p> <p>BT:</p> <p>Inquiry & Page Scan: 0.9 mA ACL no traffic: 7.5mA SCO HV3: 15.0mA</p>
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6. Pin Assignments

6.1 Pin Outline



6.2 Pin Definition

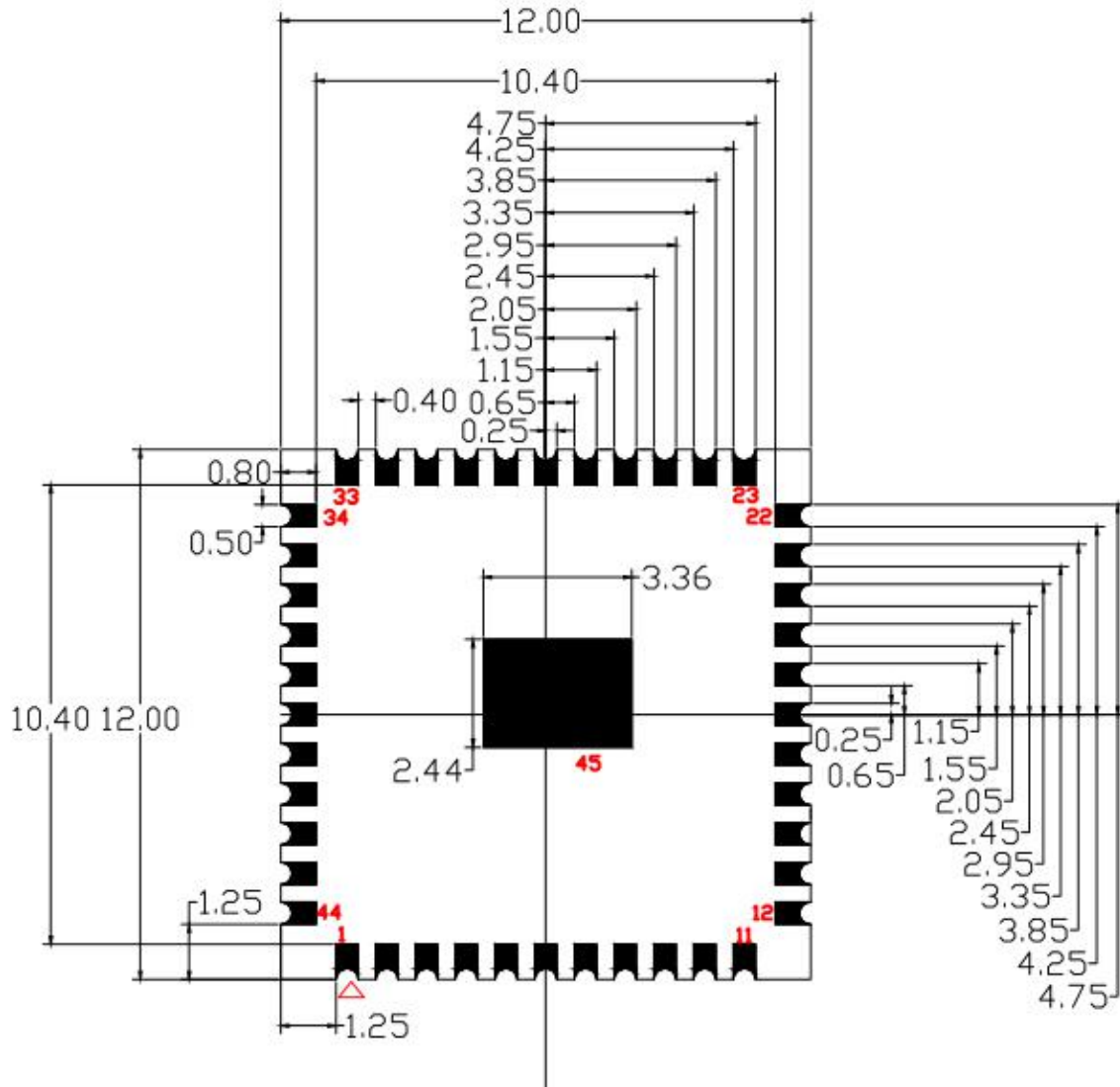
NO.	Name	Description
1	AGND	Ground connections
2	WL_BT_ANT	RF I/O port
3	AGND	Ground connections
4	NC	Floating (NC)
5	NC	Floating (NC)
6	HOST_WAKE_BT	Host to wake up Bluetooth device
7	BT_WAKE_HOST	Bluetooth device to wake up host
8	NC	Floating (NC)
9	VBAT_IN	3.3±10% V Main power voltage source input

10	NC	Floating (NC)
11	NC	Floating (NC)
12	WL_DIS#	Internal regulators power enable/disable
13	WL_HOST_WAKE	WLAN to wake up HOST
14	SD_D2	SDIO data line 2
15	SD_D3	SDIO data line 3
16	SD_CMD	SDIO command line
17	SD_CLK	SDIO clock line
18	SD_D0	SDIO data line 0
19	SD_D1	SDIO data line 1
20	AGND	Ground connections
21	NC	Floating(NC)
22	VDDIO	I/O Voltage supply input
23	NC	Floating (NC)
24	SUSCLK_IN	External Clock input(32.768kHz), need to be reserved
25	PCM_OUT	PCM Output
26	PCM_CLK	PCM Clock
27	PCM_IN	PCM Input
28	PCM_SYNC	PCM Sync
29	NC	Floating (NC)
30	MAIN_XTAL_IN	Floating (NC)
31	AGND	Ground connections
32	NC	Floating (NC)
33	AGND	Ground connections
34	BT_DIS#	BT Reset IN
35	VBAT_EN	Floating (NC)
36	AGND	Ground connections
37	NC	Floating (NC)
38	NC	Floating (NC)
39	NC	Floating (NC)
40	NC	Floating (NC)
41	UART_RTS	UART RTS
42	UART_OUT	UART Output
43	UART_IN	UART Input
44	UART_CTS	UART CTS
45	AGND	Floating (NC)

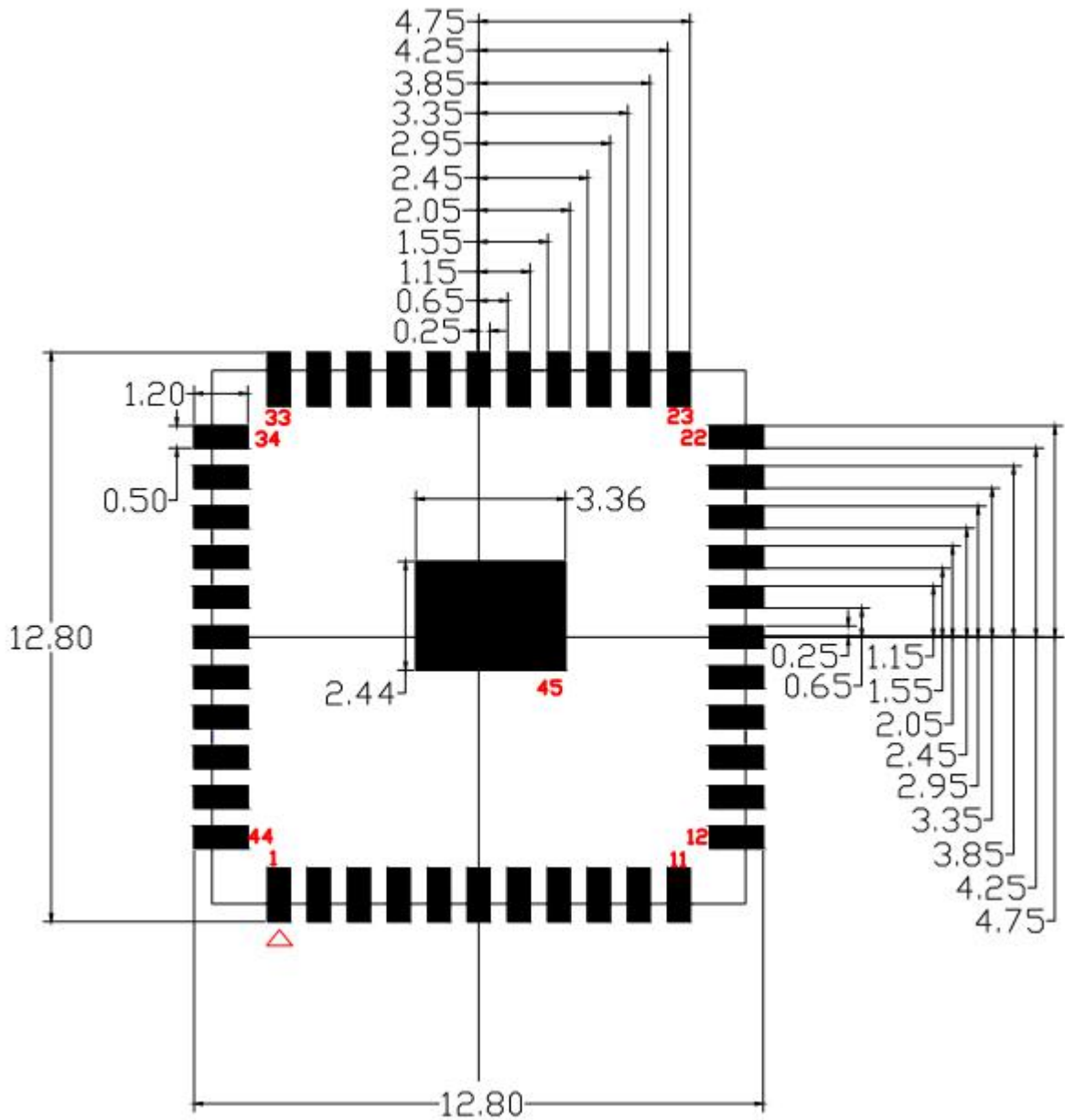
7. Dimensions

7.1 Physical Dimensions

<Bottom View>



7.2 Layout Recommendation



8. Host Interface Timing Diagram

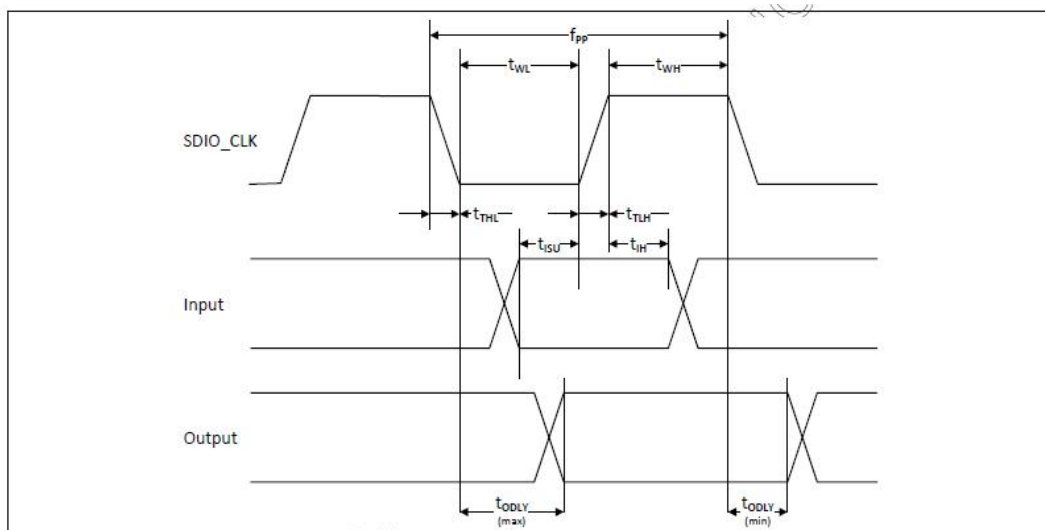
8.1 SDIO Pin Description

The module supports SDIO version 3.0 for all 1.8V 4-bit UHSI speeds: SDR50(100 Mbps), and DDR50(50MHz, dual rates) in addition to the 3.3V default speed(25MHz) and high speed (50 MHz). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This ‘out-of-band’ interrupt signal notifies the host when the WLAN device wants to turn on the SDIO interface. The ability to force the control of the gated clocks from within the WLAN chip is also provided.

SDIO Pin Description

SD 4-Bit Mode	
DATA0	Data Line 0
DATA1	Data Line 1 or Interrupt
DATA2	Data Line 2 or Read Wait
DATA3	Data Line 3
CLK	Clock
CMD	Command Line

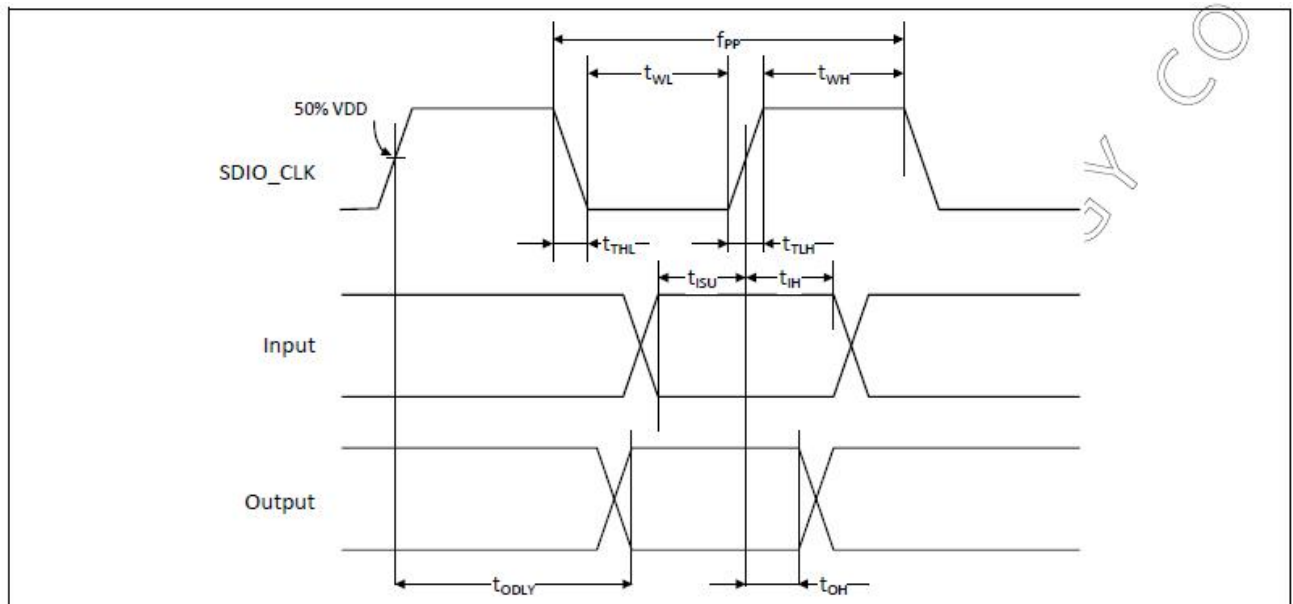
8.2 SDIO Default Mode Timing Diagram



Parameter	Symbol	Minimum	Typical	Maximum	Unit
SDIO CLK (All values are referred to minimum VIH and maximum VIL^b)					
Frequency – Data Transfer mode	fPP	0	–	25	MHz
Frequency – Identification mode	fOD	0	–	400	kHz
Clock low time	tWL	10	–	–	ns
Clock high time	tWH	10	–	–	ns
Clock rise time	tTLH	–	–	10	ns
Clock low time	tTHL	–	–	10	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup time	tISU	5	–	–	ns
Input hold time	tIH	5	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer mode	tODLY	0	–	14	ns
Output delay time – Identification mode	tODLY	0	–	50	ns

- a. Timing is based on $CL \leq 40pF$ load on CMD and Data.
 b. $\min(V_{ih}) = 0.7 \times VDDIO$ and $\max(V_{il}) = 0.2 \times VDDIO$.

8.3 SDIO High Speed Mode Timing Diagram

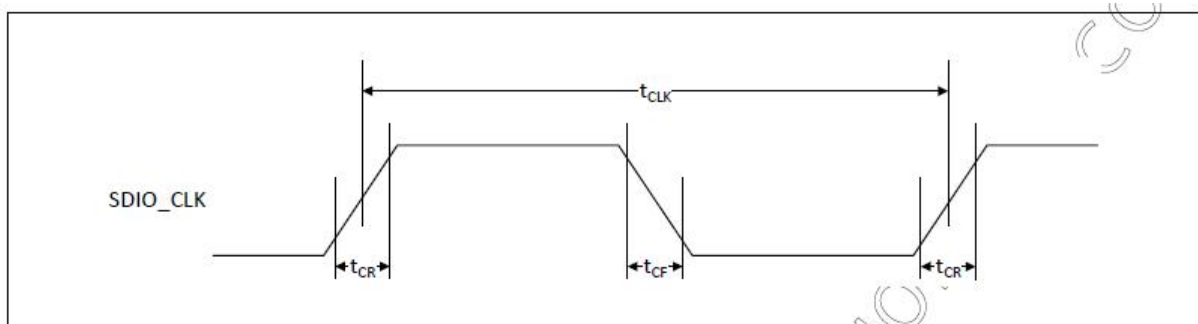


Parameter	Symbol	Minimum	Typical	Maximum	Unit
SDIO CLK (all values are referred to minimum VIH and maximum VIL^b)					
Frequency – Data Transfer Mode	fPP	0	–	50	MHz
Frequency – Identification Mode	fOD	0	–	400	kHz
Clock low time	tWL	7	–	–	ns
Clock high time	tWH	7	–	–	ns
Clock rise time	tTLH	–	–	3	ns
Clock low time	tTHL	–	–	3	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup Time	tISU	6	–	–	ns
Input hold Time	tIH	2	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer Mode	tODLY	–	–	14	ns
Output hold time	tOH	2.5	–	–	ns
Total system capacitance (each line)	CL	–	–	40	pF

- a. Timing is based on $CL \leq 40$ pF load on CMD and Data.
b. $\min(V_{ih}) = 0.7 \times V_{DDIO}$ and $\max(V_{il}) = 0.2 \times V_{DDIO}$.

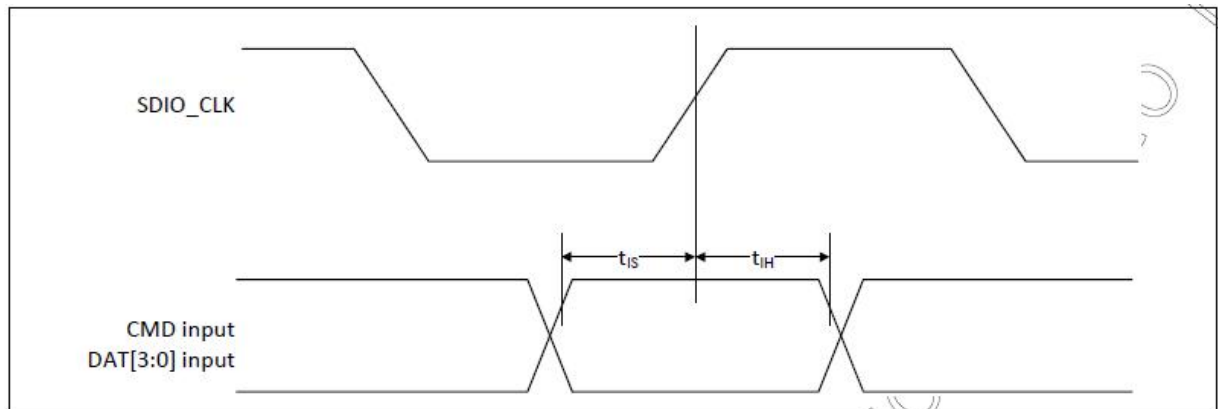
8.4 SDIO Bus Timing Specifications in SDR Modes

Clock timing(SDR Modes)



Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t _{CLK}	40	–	ns	SDR12 mode
–		20	–	ns	SDR25 mode
–		10	–	ns	SDR50 mode
–		4.8	–	ns	SDR104 mode
–	t _{CR} , t _{CF}	–	0.2 × t _{CLK}	ns	t _{CR} , t _{CF} < 2.00 ns (max) @100 MHz, C _{CARD} = 10 pF t _{CR} , t _{CF} < 0.96 ns (max) @208 MHz, C _{CARD} = 10 pF
Clock duty	–	30	70	%	–

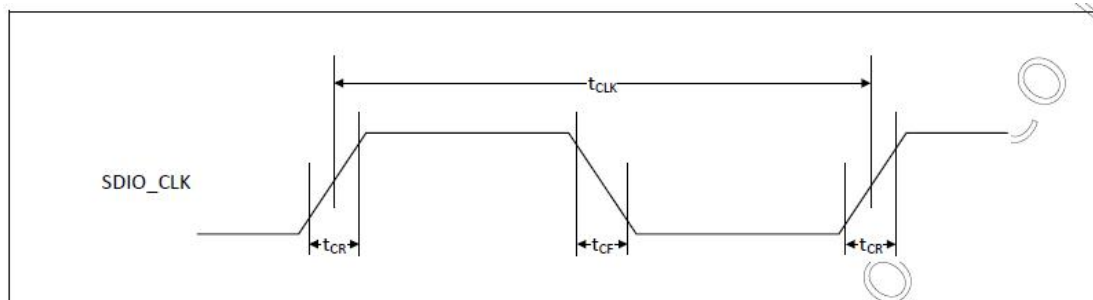
Card Input timing (SDR Modes)



Symbol	Minimum	Maximum	Unit	Comments
SDR104 Mode				
t_{IS}	1.70 ^a	–	ns	$C_{CARD} = 10 \text{ pF}$, VCT = 0.975V
t_{IH}	0.80	–	ns	$C_{CARD} = 5 \text{ pF}$, VCT = 0.975V
SDR50 Mode				
t_{IS}	3.00	–	ns	$C_{CARD} = 10 \text{ pF}$, VCT = 0.975V
t_{IH}	0.80	–	ns	$C_{CARD} = 5 \text{ pF}$, VCT = 0.975V

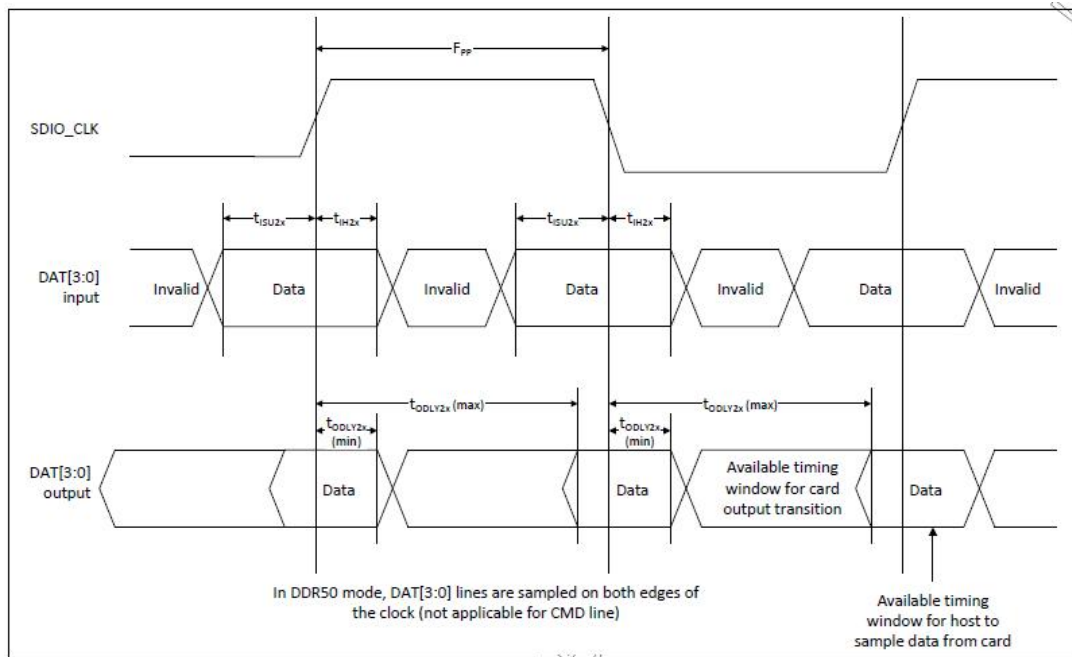
a. SDIO 3.0 specification value is 1.40 ns.

8.5 SDIO Bus Timing Specifications in DDR50 Mode



Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t_{CLK}	20	–	ns	DDR50 mode
–	t_{CR}, t_{CF}	–	$0.2 \times t_{CLK}$	ns	$t_{CR}, t_{CF} < 4.00 \text{ ns (max) @ 50 MHz}$, $C_{CARD} = 10 \text{ pF}$
Clock duty	–	45	55	%	–

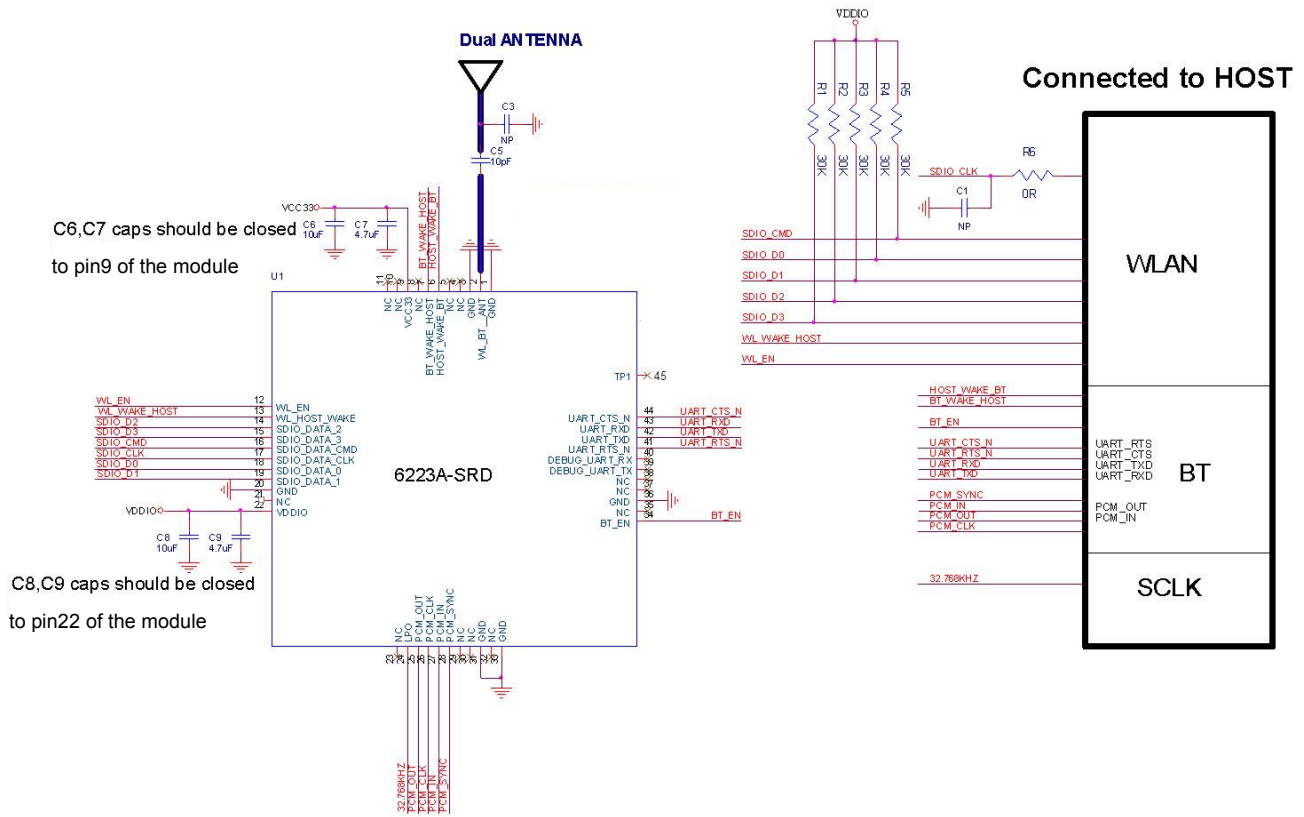
Data Timing



Parameter	Symbol	Minimum	Maximum	Unit	Comments
Input CMD					
Input setup time	t_{ISU}	6	–	ns	$C_{CARD} < 10\text{pF}$ (1 Card)
Input hold time	t_{IH}	0.8	–	ns	$C_{CARD} < 10\text{pF}$ (1 Card)
Output CMD					
Output delay time	t_{ODLY}	–	13.7	ns	$C_{CARD} < 30\text{pF}$ (1 Card)
Output hold time	t_{OH}	1.5	–	ns	$C_{CARD} < 15\text{pF}$ (1 Card)
Input DAT					
Input setup time	t_{ISU2x}	3	–	ns	$C_{CARD} < 10\text{pF}$ (1 Card)
Input hold time	t_{IH2x}	0.8	–	ns	$C_{CARD} < 10\text{pF}$ (1 Card)
Output DAT					
Output delay time	t_{ODLY2x}	–	7.85 ^a	ns	$C_{CARD} < 25\text{pF}$ (1 Card)
Output hold time	t_{ODLY2x}	1.5	–	ns	$C_{CARD} < 15\text{pF}$ (1 Card)

^a SDIO 3.0 specification value is 7.0 ns.

9. Reference Design



10. The Key Material List

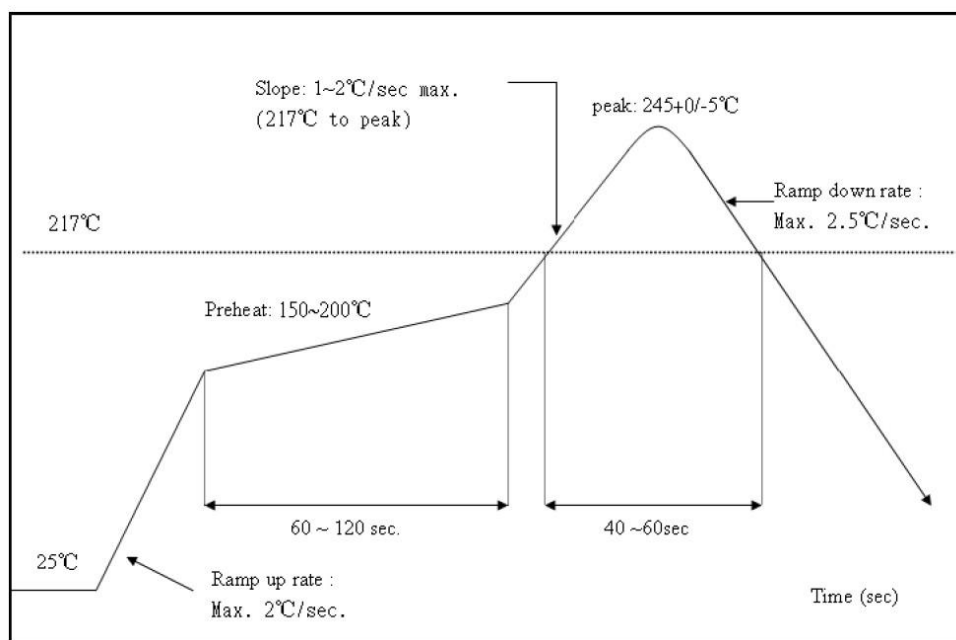
主料	主 IC	RTL8723DS_QFN48
主料	PCB	F23DSSM23_20160513 12X12X0.6mm 四层板 板材 FR4 (翔宇)
主料	SMD 晶振	2520 24MHz 12pF 10ppm (TST)
替代料	SMD 晶振	2520 24MHz 12pF 10ppm E2SB24E00000LE Hosonic (鸿星)

11. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <250°C

Number of Times : ≤2 times



12. Package

the take-up package



Using self-adhesive tape

Size of black tape: 24mm*32.6m the cover tape :2.13mm*32.6m

Color of plastic disc: blue

A roll of 2000pcs



NY bag size:460mm*385mm



size : 350*350*35mm



The packing case size:350*210*370mm

FCC Statement:

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

WARNING: Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

LABEL OF THE END PRODUCT:

The final end product must be labelled in a visible area with the following "Contains TX FCC ID: 2AATL-6223A-SRD". If the size of the end product is smaller than 8x10cm, then additional FCC part 15.19 statement is required to be available in the users manual: This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

RF Exposure

This device has been evaluated and shown compliant with the FCC RF Exposure limits under fixed exposure conditions (antennas are greater than 20cm from a person's body) when installed in certain specific OEM configurations.

This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. Due to missing shielding the module is strictly limited to integration by the Grantee himself or his dedicated OEM integrator under control of the Grantee. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed.

IMPORTANT NOTE:

This module is intended for OEM integrator only and the OEM integrators and instructed to ensure that the end user has no manual instructions to remove or install the device. The OEM integrator is still responsible for the FCC compliance requirement of the end product, which integrates this module.

Integration is typically strictly restricted to Grantee himself or dedicated OEM integrators under control of the Grantee.

In the event that these conditions can not be met (for example certain laptop configurations or co-location with another transmitter. then the FCC authorization is no longer considered valid and the FCC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

The module will be responsible to satisfy SAR/RF Exposure requirements, when the module integrated into any (portable, mobile, fixed) host device.

This module has been designed to operate with a PIFA antenna having a maximum gain of 2.99dBi. Only this type of antenna may be used, the manufacturer recommended antenna as below:

No.	Brand	Model name	Antenna Type	Connector	Gain (dBi)
1	ZHONGTIAN XUN	2.00001213	PIFA	I-PEX	2.99
2	XK	XKFPC-2D4-5D8-1 50	PIFA	I-PEX	0.0
3	XK	XK-QX2400-PCB-1 40	PIFA	I-PEX	2.0
4	ZHONGTIAN XUN	2.00001050	PIFA	I-PEX	0.38

The module must in the end-product be installed in such manner that the authorized antennas can be used, any change of the antenna will void the certification.

EU Regulatory Conformance

Hereby, we(FN-LINK TECHNOLOGY LIMITED) declared that this device is in compliance with the essential requirements and other relevant provisions of Directive 2014/53/EU